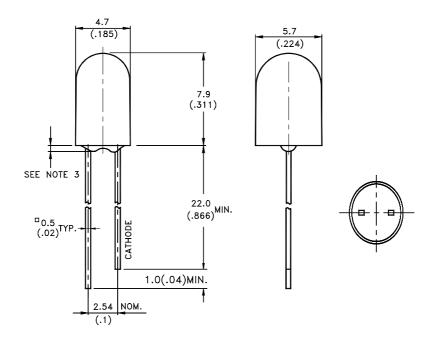
Property of LITE-ON Only

Features

- * High Luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Wide Viewing Angle
 - Major Axis 70° / Minor Axis 35°
- * Versatile mounting on P.C. board or panel.
- * I.C. Compatible/low current requirements.

Package Dimensions



Part No.	Lens	Source Color
LTL5V3SRK	Water Clear	AlInGaP Super Red

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

Property of LITE-ON Only

Parameter	Maximum Rating	Unit
Power Dissipation	130	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
Continuous Forward Current	50	mA
Derating Linear From 50°C	0.6	mA/°C
Reverse Voltage	5	V
Operating Temperature Range	-40° C to $+100^{\circ}$ C	
Storage Temperature Range	-55° C to $+ 100^{\circ}$ C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260° C for 5 Seconds	

	Part No. : LTL5V3SRK	Page :	2	of
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Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	680	1500		mcd	I _F = 20mA Note 1,5
Viewing Angle	2 heta 1/2		70 / 35		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λp		639		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd		630		nm	Note 4
Spectral Line Half-Width	Δλ		17		nm	
Forward Voltage	VF		2.2	2.6	v	IF = 20mA
Reverse Current	Ir			100	μA	$V_R = 5V$
Capacitance	С		40		pF	$V_F = 0$, $f = 1MHz$

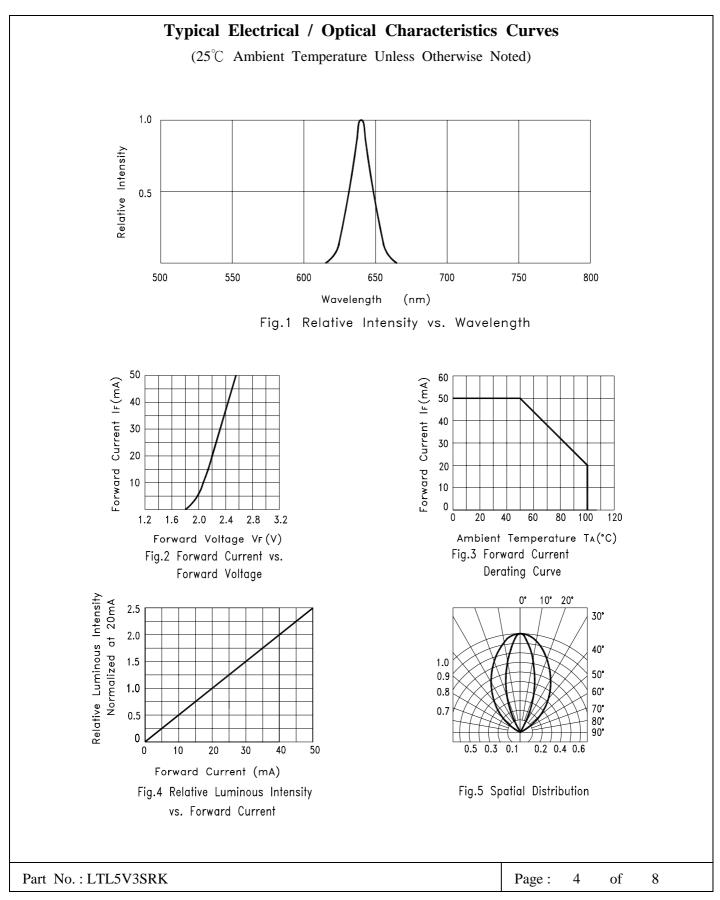
- NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
 - 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
 - 3. Iv classification code is marked on each packing bag.
 - 4. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
 - 5. The Iv guarantee should be added $\pm 15\%$ tolerance.

Part No.: LTL5V3SRK

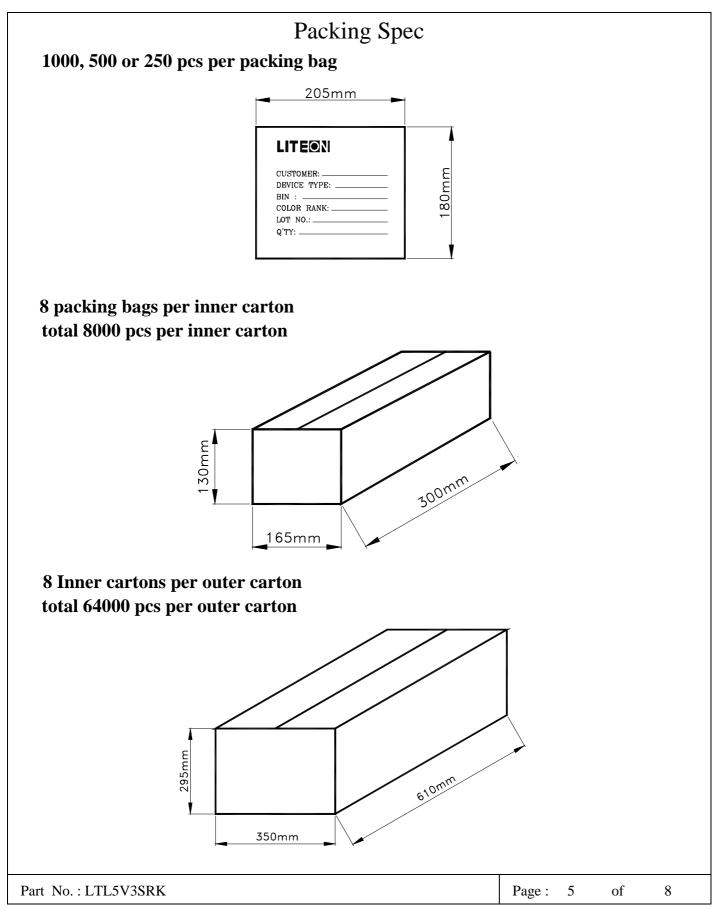
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BNS-OD-C131/A4

Property of LITE-ON Only



Property of LITE-ON Only



Property of LITE-ON Only

Luminou	Luminous Intensity Unit : mcd @20mA			
Bin Code	Min.	Max.		
Ν	680	880		
Р	880	1150		
Q	1150	1500		
R	1500	1900		
S	1900	2500		
Т	2500	3200		

Bin Code List For Reference

Dominant Wavelength Unit : nm @20mA				
Bin Code	Min.	Max.		
H029	621.0	625.0		
H030	625.0	629.0		
H031	629.0	633.0		
H032	633.0	637.0		

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CAUTIONS

1. Application limitation

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application.) Consult Liteon's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2. Storage

After being shipped from Liteon the LEDs should be kept at 30°C or less and 70% RH or less. The LEDs should be used within 3 months. They can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material. Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

4. Forming & Mounting

When forming a lead, the leads should be bent at a point at least 3mm from the base of epoxy bulb. Do not use the base of the leadframe as a fulcrum during forming. Lead forming must be done before soldering at normal temperature. When mounted through hole type LED lamp, avoid the occurrence of residual mechanical stress due to clinching as figure shown here.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the resin to the soldering point. Dipping the resin into the solder must be avoided.

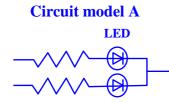
Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	

6. Drive Method

LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the drive circuit. This current limiting typically takes the form of a current limiter resistor placed in series with the LED. Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.





LFD

(A) Recommended circuit.

(B) The difference of brightness between LEDs could be found due to the Vf-If characteristics of LED

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Property of LITE-ON Only

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti- electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

8. Reliability Test

Classification	Test Item	Test Condition	Referance Standard		
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)		
	High Temperature High Humidity Storage	Ta= $65\pm5^{\circ}$ C RH= 90 ~ 95% Test Time= 240HRS \pm 2HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)		
Endurance Test	High Temperature High Humidity Reverse BIAS	Ta= $65\pm5^{\circ}$ C RH= 90 ~ 95% VR=5V Test Time = 500HRS (-24HRS, +48HRS)	JIS C 7021 : B-11(1982)		
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)		
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)		
	Temperature Cycling	$105^{\circ}C \sim 25^{\circ}C \sim -55^{\circ}C \sim 25^{\circ}C$ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)		
Environmental Test	Thermal Shock	$105 \pm 5^{\circ} \text{C} \sim -55^{\circ} \text{C} \pm 5^{\circ} \text{C}$ 10mins 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)		
	Solder Resistance	T.sol= $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)		
	Solderability	T.sol= $230 \pm 5^{\circ}$ C Dwell Time= 5 ± 1 secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)		

9. Others

The appearance and specifications of the product may be modified for improvement without notice.